

PRM® Regulator Remote Sense Only PRM48Bx480y600A00

High Efficiency Remote Sense PRM Converter

FEATURES

- 45V (38 to 55 $V_{\mbox{\scriptsize IN}}),$ non-isolated ZVS buck-boost regulator
- 5 to 55 V adjustable output range
- Building block for high efficiency DC-DC systems
- 600W Output Power in 1.11 in² footprint
- 97.6% typical efficiency, at full load
- 2,072 W/in³ (124 W/cm³) Power Density
- Enables a 48 V to 1.5 V, 345 A isolated, regulated solution with total footprint of 3.3in² (21cm²)
- Flexible "Remote Sense" architecture optimizes regulation / feedback loop design to fit application requirements
- Current Feedback signal allows dynamic adjustment of current limit setpoint
- 6.36 MHrs MTBF (MIL-HDBK-217Plus Parts Count)

TYPICAL APPLICATIONS

- High Efficiency Server Processor and Memory Power
- High Density ATE system DC-DC power
- Telecom NPU and ASIC core power
- LED drivers
- High Density Power Supply DC-DC rail outputs
- Non-isolated power converters

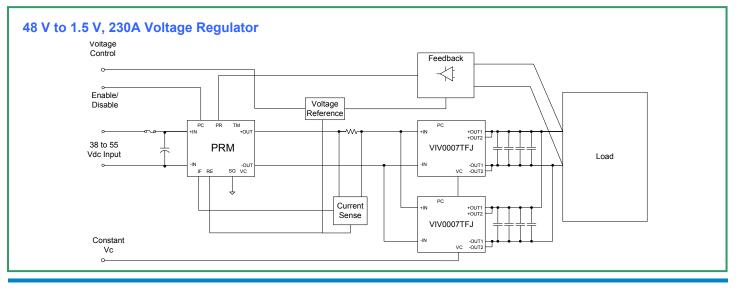
DESCRIPTION

The VI Chip PRM[®] Regulator is a high efficiency converter, operating from a 38 to 55 Vdc input to generate a regulated 5 to 55 Vdc output. The ZVS Buck – Boost topology enables high switching frequency (~1 MHz) operation with high conversion efficiency. High switching frequency reduces the size of reactive components enabling power density up to 2,072 W/in³.

The full VI Chip package is compatible with standard pick-and-place and surface mount assembly processes with a planar thermal interface area and superior thermal conductivity.

In a Factorized Power Architecture[™] system, the PRM48BF480T600A00 and downstream VTM[™] transformer minimize distribution and conversion losses in a high power solution.

An external control loop and current sensor maintain regulation and enable flexibility both in the design of voltage and current compensation loops to control of output voltages and currents.



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1.0 ABSOLUTE MAXIMUM RATINGS

The ABSOLUTE MAXIMUM ratings below are stress ratings only. Operation at or beyond these maximum ratings can cause permanent damage to device. Electrical specifications do not apply when operating beyond rated operating conditions. All voltages are specified relative to SG unless otherwise noted. Positive pin current represents current flowing out of the pin.

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	Min	Max	Unit
PR	-0.3	10.5	V
		10	mA
PC	-0.3	5.7	V
FC		10	mA
TM	-0.3	5.7	V
111		1	mA
+IN to -IN	-1	62	V
VS	-0.5	10.5	V
vo		100	mA
SG		100	mA
IF	-0.5	5.7	V
RE	-0.3	5	V
	-0.5	18	V
VC to -OUT	······································	1.8	Α
+OUT to -OUT	-1	62	V
Output Current		17	Α
Operating Analog IC Junction Temperature	-40	125	°C
Storage Temperature	-40	125	°C

2.0 ELECTRICAL CHARACTERISTICS

Specifications apply over all line and load conditions, $T_J = 25$ °C and output voltage from 20V to 55V, unless otherwise noted. Boldface specifications apply over the temperature range of -40 °C < T_J < 125 °C (T-grade).

Specifications apply over all line and lo	ad conditions, a	ELECTRICAL CHARACTERISTICS and trim from 20V to 55V, unless otherwise noted;				
		re range of -40 °C < T _J < 125 °C (T-Grade); All Other specifications are at T _J = 25 °C unless other	vise noted			
Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
POWER INPUT SPECIFICATION						
	M		20	45		v
Input Voltage range	VIN	0	38	45	55	-
V _{IN} Slew Rate	dV _{IN} /dt	0 < V _{IN} < 18 V	0.001		1000	V/ms
No Load Power Dissipation	P _{NL}	PC High, V _{IN} = 45 V		2.0	4	W
Input Quiescent current	l _{QC}	PC Low, V_{IN} = 45 V. I _{QC} is roughly 33% of value listed if PC has never been permitted to go HIGH since power applied.		5.0	10.0	mA
Input Current	IIN DC	I _{OUT} = 12.5A, V _{IN} = 38 V, V _{OUT} = 48 V		16.3	16.5	Α
Input Capacitance (Internal)	CIN INT	Effective value, V _{IN} = 45 V (see Fig. 20)		4		μF
Input Capacitance (Internal) ESR	R _{Cin}			1.5		mΩ
POWER OUTPUT SPECIFICATION						
Output Voltage range	Vout		5	48	55	v
Output Current	lout	See Fig.16, SOA			12.5	A
Output Power	Pour	See Fig.16, SOA			600	Ŵ
		From V _{IN} applied, PC floating				VV
Output Turn-ON Delay	Ton	From PC pin release, V _{IN} applied, T _{OFF} expired		20		μs
		Equal input, output and PR voltage at full load; VIN = 45 V, VOUT = 48 V, exclusive of current limit			±10	%
Current Sharing accuracy	I _{OUT_PS}	Equal input, output and PR voltage at full load;			See sec	
		Over line, trim, and temperature; exclusive of current limit			10.6	%
	η	Nominal line, full load, Vourt = 48V	96.6	97.6		%
Efficiency		50% load and $V_{OUT} = 48$ V; over temperature	95.0	31.0		%
Elliciency		50% load; over temperature	91.0			%
Output Discharge current	IOD	50 % load, over temperature	51.0	0.5		mA
Output Discharge Current Output Voltage Ripple	VOUT PP	C _{OUT EXT} = 0 F, I _{OUT} = 12.5 A, V _{IN} = 45 V, V _{OUT} = 48 V, 20 MHz BW		900	1500	mV
Output Inductance (Parasitic)	LOUT PAR	Frequency @ 1 MHz, Simulated J-Lead model		1.9	1300	nH
Output Inductance (Parasitic)	COUT INT	Effective value, V _{OUT} = 48 V (see Fig. 20)		4		μF
Output Capacitance (Internal) Output Capacitance (Internal) ESR	R _{Cout}	Lifective value, v _{OUT} = 40 V (see Fig. 20)		1.5		mΩ
	Cout			1.5		11152
POWERTRAIN PROTECTIONS						
Input Undervoltage Turn-ON	VIN UVLO+	Instantanous powertrain shutdown, latched after T _{BLNK}		35.75	37.13	V
Input Undervoltage Turn-OFF	VIN UVLO-		31.97	33.56		V
Input Overvoltage Turn-ON	VIN OVLO+	Instantanous powertrain shutdown, latched after T _{BLNK}	55.91	57.24		V
Input Overvoltage Turn-OFF	VIN OVLO-			58.44	59.91	V
Overcurrent (IF) and Input	TBLNK		50	120	150	μs
Over/Undervoltage Blanking Time						
Output Overvoltage Threshold	VOUT OVLO+		55.57	57.75	60.00	V
Thermal Shutdown Setpoint	T _{J OTP}	Instantaneous, latched shutdown; guaranteed by design, not production tested; V_{TM} = 4.03V	130			°C
Overtemperature, Output Overvoltage	TPROT			2		μS
and PC Shutdown Response Time						•
Short Circuit Vout Threshold	V _{SC VOUT}			3.37		V
Short Circuit Vout Recovery Threshold	V _{SC VOUTR}			4.46		V
Short Circuit Vpr Threshold	V _{SC VPR}			7.1		V
Short Circuit Vpr Recovery Threshold	V _{SC VPRR}			6.9		V
Short Circuit Timeout	T _{SC}	Short Circuit fault latched after V _{SC VOUT} and V _{SC VPR} thresholds persist for this time		20		ms
Short Circuit Recovery Time	T _{SCR}			0.1		ms
Output Power Limit	PPROT		600			W



3.0 SIGNAL CHARACTERISTICS

Specifications apply over all line and load conditions, $T_J = 25$ °C and Output Voltage from 20V to 55V, unless otherwise noted. Boldface specifications apply over the temperature range of -40 °C < T_J < 125 °C (T-grade).

Voltage Source • Intended to power feedback compo								
- intended to power reeuback compo	VS onents and/or auxilia	ary circuits.						
9 V, 5mA regulated voltage source								
 With > 5% output load, VS ripple ty 						_		
Signal Type	State	Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
		VS Voltage	V _{vs}		8.55	9.00	9.45	V
	Regular Operation	VS Available Current	Ivs		5			mA
Analog Output	Operation	VS Voltage Ripple	V _{VS_PP}	lout = 0A, Cvs_ext=0. Maximum specification includes powertrain operation in burst mode.		100	400	mV
		VS Capacitance (External)	C _{VS EXT}	includes powertrain operation in burst mode.			0.04	μF
	Transition	VS Fault Response Time		From fault recognition to VS = 1.5 V		30	0.04	μs
			• FR_V5			00		μο
		-						
Reference Enable	RE							
 RE signals succesfull startup and p Intended to power and enable the f 								
 3.3V, 8mA regulated voltage source 								
Signal Type	State	Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
		RE Voltage	V _{RE}		3.0	3.3	3.6	v
	Regular	RE Available Current	IRE		8.0			mA
	Operation	RE Regulation	%RE	across load and temperature	0.0	±2.5		%
Analog Output		RE Voltage Ripple	V _{RE PP}	in burst mode		100		mV
		PC to RE Delay	T _{PC RE}	Fault detected		100		μs
	Transition	RE Capacitance (External)	C _{RE EXT}			100	0.1	<u>μ</u> 5 μF
	Transition	VS to RE Delay		VS = 8.1 V to RE high, V _{IN} > V _{IN UVLO-}		1	0.1	ms
	-	VS to RE Delay	VS_RE					1115
		_						
Control Node	PR							
Modulator control node input								
0.5mA constant current sink when								
0.79V, up to 2mA voltage source w								
Signal Type	State	Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
		PR Voltage Active Range	V _{PR}		0.79		7.40	v
		The Foldage Float of Hallinge	• PR		0.75		7.40	
	Regular	PR Source Current	I _{PR}	$V_{PR} \le 0.79V$	0.10		2	mA
Analog Input	Regular Operation		I _{PR}		250	500	9 2	
Analog Input		PR Source Current		$V_{PR} \le 0.79V$ $V_{PR} > 0.79V$		500 93.3	2	mA
Analog Input		PR Source Current PR Sink Current	I _{PR} I _{PR_Low}				2	mA μA
	Operation	PR Source Current PR Sink Current	I _{PR} I _{PR_Low}				2	mA μA
Current Feedback	Operation	PR Source Current PR Sink Current PR Resistance to SG	I _{PR} I _{PR_Low} R _{PR}	V _{PR} > 0.79V	250	93.3	2 750	mA μA
Current Feedback • A voltage proportional to the PRM	Operation IF output current must	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin	I _{PR} I _{PR_Low} R _{PR} in order for		250	93.3	2 750	mA μA
Current Feedback A voltage proportional to the PRM Overcurrent protection trip will cause	Operation IF Output current must se instantaneous po	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK}	I _{PR} I _{PR_Low} R _{PR} in order for	V _{PR} > 0.79V the device to properly protect overcurrent events and t	250 to enable outp	93.3 out current lin	2 750 nit (clamp)	mA μA kΩ
	Operation IF output current must	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK} Attribute	I _{PR} I _{PR_Low} R _{PR} in order for	V _{PR} > 0.79V the device to properly protect overcurrent events and t Conditions / Notes	250 to enable outp	93.3 out current lin Typ	2 750 nit (clamp) Max	mA μA
Current Feedback A voltage proportional to the PRM Overcurrent protection trip will caus	Operation IF output current must se instantaneous po State	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK}	I _{PR} I _{PR_Low} R _{PR} in order for Symbol V _{IF_IL}	$V_{PR} > 0.79V$ the device to properly protect overcurrent events and the device to prove the device to protect overcurrent events events and the device to protect overcurrent events even	250 to enable outp	93.3 out current lin Typ 2.00	2 750 nit (clamp)	mA μA kΩ Unit
Current Feedback A voltage proportional to the PRM Overcurrent protection trip will caus Signal Type	Operation IF output current must se instantaneous pc State Regular	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK} Attribute	I _{PR} I _{PR_Low} R _{PR} in order for Symbol V _{IF_IL}	$V_{PR} > 0.79V$ the device to properly protect overcurrent events and t Conditions / Notes $V_{IN} = 45 V; T_J = 25 °C$ Not Production Tested; Guaranted by Design;	250 to enable outp	93.3 out current lin Typ	2 750 nit (clamp) Max	mA μA kΩ
Current Feedback A voltage proportional to the PRM Overcurrent protection trip will caus	Operation IF output current must se instantaneous po State	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNR} Attribute Current Limit (clamp) Threshold Overcurrent Protection Threshold	I _{PR} I _{PR_Low} R _{PR} in order for Symbol V _{IF_IL} V _{IF_OC}	$V_{PR} > 0.79V$ the device to properly protect overcurrent events and the device to prove the device to protect overcurrent events events and the device to protect overcurrent events	250 to enable outp <u>Min</u> 1.90 2.58	93.3 out current lin Typ 2.00 2.69	2 750 nit (clamp) <u>Max</u> 2.10 2.80	mA μA kΩ Unit
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Current Feedback A voltage proportional to the PRM overcurrent protection trip will caus Signal Type Analog Input Primary Control The PC pin enables and disables t In PRM array configurations, PC p PC pin is 5 V during normal operat It is a weak pull-down during any fr Signal Type	Operation IF output current must se instantaneous pc State Regular Operation PC the PRM; When he ins should be conn tion. ault mode excluding State Regular Operation	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNW} Attribute Current Limit (clamp) Threshold Overcurrent Protection Threshold IF Input Impedance Current Limit Bandwidth Id below ~2.4 V the PRM will be dis ected in order to synchronize startu g short circuit. PC is a strong pull-c Attribute PC Voltage PC Available Current	IPR IPR_LOW RPR in order for Symbol VIF_IL VIF_OC RIF BWIL sabled. up. lown to SG Symbol VPC IPC_OP	V _{PR} > 0.79V the device to properly protect overcurrent events and t Conditions / Notes V _{IN} = 45 V; T _J = 25 °C Not Production Tested; Guaranted by Design; T _J = 25 °C if a Short Circuit fault is latched. Conditions / Notes	250 to enable outp 1.90 2.58 2.11 Min 4.7	93.3 put current lin Typ 2.00 2.69 2.13 2 Typ	2 750 mit (clamp) Max 2.10 2.80 2.15 Max	mA μA kΩ Unit V kΩ kHz Unit
Current Feedback A voltage proportional to the PRM overcurrent protection trip will caus Signal Type Analog Input Primary Control The PC pin enables and disables t In PRM array configurations, PC p PC pin is 5 V during normal operal It is a weak pull-down during any fr Signal Type	Operation IF Output current must se instantaneous po State Regular Operation PC the PRM; When he ins should be conn tion. ault mode excludin, State Regular	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK} Attribute Current Limit (clamp) Threshold Overcurrent Protection Threshold IF Input Impedance Current Limit Bandwidth Id below ~2.4 V the PRM will be dis ected in order to synchronize startu g short circuit. PC is a strong pull-c Attribute PC Voltage PC Available Current PC Source Current	IPR IPR_Low RPR in order for Symbol VIF_IL VIF_OC RIF BWIL sabled. Jp. iown to SG Symbol VPC IPC_OP	VPR > 0.79V the device to properly protect overcurrent events and the device to properly protect overcurrent events and the device to product on Conditions / Notes VIN = 45 V; TJ = 25 °C Not Production Tested; Guaranted by Design; TJ = 25 °C if a Short Circuit fault is latched. Conditions / Notes After T _{OFF}	250 to enable outp <u>Min</u> 1.90 2.58 2.11 <u>Min</u> 4.7 1.8	93.3 put current lin Typ 2.00 2.69 2.13 2 Typ 90	2 750 Max 2.10 2.80 2.15 Max 5.3	mA μA kΩ Uni V kΩ kHz Unit
Current Feedback A voltage proportional to the PRM overcurrent protection trip will caus Signal Type Analog Input Primary Control The PC pin enables and disables t In PRM array configurations, PC p PC pin is 5 V during normal operal It is a weak pull-down during any fr Signal Type	Operation IF Output current must se instantaneous pc State Regular Operation PC the PRM; When he ins should be conn tion. ault mode excluding State Regular Operation State Regular Operation Startup	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNH} Current Limit (clamp) Threshold Overcurrent Protection Threshold IF Input Impedance Current Limit Bandwidth Id below ~2.4 V the PRM will be dis ected in order to synchronize startu g short circuit. PC is a strong pull-c Attribute PC Voltage PC Available Current PC Source Current Minimum Time to Start	IPR IPR_Low RPR in order for Symbol VIF_IL VIF_OC RIF BWIL sabled. up. town to SG Symbol VPC IPC_OP IPC_EN TOFF	V _{PR} > 0.79V the device to properly protect overcurrent events and t Conditions / Notes V _{IN} = 45 V; T _J = 25 °C Not Production Tested; Guaranted by Design; T _J = 25 °C if a Short Circuit fault is latched. Conditions / Notes	250 to enable outp 1.90 2.58 2.11 Min 4.7	93.3 put current lin Typ 2.00 2.69 2.13 2 Typ 90 18.0	2 750 Max 2.10 2.80 2.15 Max 5.3 30.0	mA μA kΩ Unit V kΩ kHz Unit V V MA μA ms
Current Feedback A voltage proportional to the PRM overcurrent protection trip will caus Signal Type Analog Input Primary Control The PC pin enables and disables t In PRM array configurations, PC p PC pin is 5 V during normal operal It is a weak pull-down during any fi Signal Type Analog Output	Operation IF output current must se instantaneous pc State Regular Operation PC the PRM; When he ins should be conn tion. ault mode excluding State Regular Operation	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNH} Current Limit (clamp) Threshold Overcurrent Protection Threshold IF Input Impedance Current Limit Bandwidth Id below ~2.4 V the PRM will be dis ected in order to synchronize startu g short circuit. PC is a strong pull-c Attribute PC Voltage PC Available Current PC Source Current Minimum Time to Start PC Enable Threshold	IPR IPR_Low RPR in order for Symbol VIF_IL VIF_OC RIF BWIL sabled. Jp. fown to SG Symbol VPC IPC_OP IPC_EN TOFF VPC_EN	VPR > 0.79V the device to properly protect overcurrent events and the device to properly protect overcurrent events and the device to product on Conditions / Notes VIN = 45 V; TJ = 25 °C Not Production Tested; Guaranted by Design; TJ = 25 °C if a Short Circuit fault is latched. Conditions / Notes After T _{OFF}	250 to enable outp Min 1.90 2.58 2.11 Min 4.7 1.8 10.0	93.3 put current lin Typ 2.00 2.69 2.13 2 Typ 90 18.0 2.50	2 750 Max 2.10 2.80 2.15 Max 5.3	mA μA kΩ Unit V kΩ kHz Unit V kΩ kHz V MA μA ms V
Current Feedback A voltage proportional to the PRM overcurrent protection trip will caus Signal Type Analog Input Primary Control The PC pin enables and disables t In PRM array configurations, PC p PC pin is 5 V during normal operal It is a weak pull-down during any fi Signal Type Analog Output	Operation IF Output current must se instantaneous po Regular Operation PC the PRM; When he ins should be conn tion. ault mode excludin, State Regular Operation State Startup Startup Startup	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK} Attribute Current Limit (clamp) Threshold Overcurrent Protection Threshold IF Input Impedance Current Limit Bandwidth Id below ~2.4 V the PRM will be dis ected in order to synchronize startu g short circuit. PC is a strong pull-c Attribute PC Voltage PC Available Current PC Source Current Minimum Time to Start PC Enable Threshold PC Disable Threshold	IPR IPR_LOW RPR Symbol VIF_IL VIF_OC RIF BWIL Sabled. JP. Sabled. JP. Sown to SG Symbol VPC IPC_OP IPC_EN TOFF VPC_EN	V _{PR} > 0.79V the device to properly protect overcurrent events and t Conditions / Notes V _{IN} = 45 V; T _J = 25 °C Not Production Tested; Guaranted by Design; T _J = 25 °C if a Short Circuit fault is latched. Conditions / Notes After T _{OFF} Section 5.0	250 to enable out; Min 1.90 2.58 2.11 4.7 1.8 10.0 1.75	93.3 put current lin Typ 2.00 2.69 2.13 2 Typ 90 18.0	2 750 Max 2.10 2.80 2.15 Max 5.3 30.0	mA μA kΩ V V kHz kHz Unit v kHz V v kHz V V V V
Current Feedback A voltage proportional to the PRM Overcurrent protection trip will caus Signal Type Analog Input Primary Control The PC pin enables and disables t In PRM array configurations, PC p PC pin is 5 V during normal operal It is a weak pull-down during any f: Signal Type Analog Output Digital Input / Output	Operation IF output current must se instantaneous pc Regular Operation PC the PRM; When he ins should be conn tion. ault mode excluding Regular Operation State Regular Operation Startup Startup Startup Standby	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK} Attribute Current Limit (clamp) Threshold Overcurrent Protection Threshold IF Input Impedance Current Limit Bandwidth I I I I I I I I I I I I I I I I I I I	IPR IPR_Low RPR in order for Symbol VIF_IL VIF_OC RIF BWIL sabled. Jp. fown to SG Symbol VPC IPC_OP IPC_EN TOFF VPC_EN	VPR > 0.79V the device to properly protect overcurrent events and i Conditions / Notes VIN = 45 V; TJ = 25 °C Not Production Tested; Guaranted by Design; TJ = 25 °C if a Short Circuit fault is latched. Conditions / Notes After T _{OFF} Section 5.0 Max Resistance to SG required to disable the PRM	250 to enable outp Min 1.90 2.58 2.11 Min 4.7 1.8 10.0	93.3 put current lin Typ 2.00 2.69 2.13 2 Typ 90 18.0 2.50	2 750 Max 2.10 2.80 2.15 Max 5.3 30.0	mA μA kΩ Unit V kΩ kHz Unit V kΩ kHz V MA μA ms V
Current Feedback A voltage proportional to the PRM overcurrent protection trip will caus Signal Type Analog Input Primary Control The PC pin enables and disables t In PRM array configurations, PC p PC pin is 5 V during normal operal It is a weak pull-down during any fi Signal Type Analog Output	Operation IF Output current must se instantaneous po Regular Operation PC the PRM; When he ins should be conn tion. ault mode excludin, State Regular Operation State Startup Startup Startup	PR Source Current PR Sink Current PR Resistance to SG be supplied externally to the IF pin wertrain disable, latched after T _{BLNK} Attribute Current Limit (clamp) Threshold Overcurrent Protection Threshold IF Input Impedance Current Limit Bandwidth Id below ~2.4 V the PRM will be dis ected in order to synchronize startu g short circuit. PC is a strong pull-c Attribute PC Voltage PC Available Current PC Source Current Minimum Time to Start PC Enable Threshold PC Disable Threshold	IPR IPR_LOW RPR Symbol VIF_IL VIF_OC RIF BWIL Sabled. JP. Sabled. JP. Sown to SG Symbol VPC IPC_OP IPC_EN TOFF VPC_EN	V _{PR} > 0.79V the device to properly protect overcurrent events and t Conditions / Notes V _{IN} = 45 V; T _J = 25 °C Not Production Tested; Guaranted by Design; T _J = 25 °C if a Short Circuit fault is latched. Conditions / Notes After T _{OFF} Section 5.0	250 to enable out; Min 1.90 2.58 2.11 4.7 1.8 10.0 1.75	93.3 put current lin Typ 2.00 2.69 2.13 2 Typ 90 18.0 2.50	2 750 Max 2.10 2.80 2.15 Max 5.3 30.0	mA μA kΩ V V kHz kHz Unit v kHz V v kHz V V V V



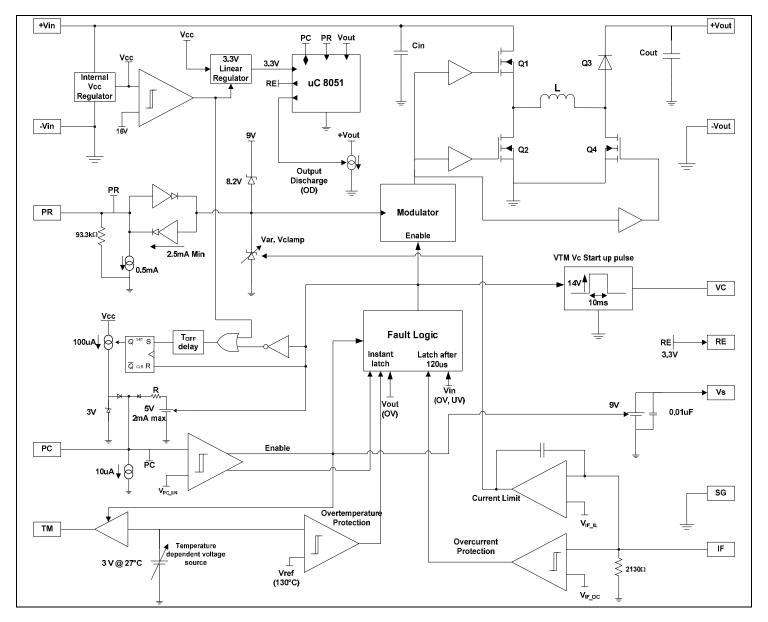
Temperature Monitor	TM							
The TM pin monitors the internal te	emperature of the PF	M analog control IC to within ±5	°C.					
Room temperature setpoint is ~ 3	V, approximate gain	is 10 mV/°C.						
· "Power Good" flag to verify that the	e PRM is operating							
Signal Type	State	Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
Analog Output		TM Voltage	V _{TM}	Full temperature range	2.12		4.04	V
	Devider	TM Voltage reference	V _{TM_AMB}	T _J = 27 °C	2.94	3.00	3.06	V
	Regular Operation	TM Voltage Ripple	V _{VS_PP}	powertrain in burst mode		200		mV
		TM Available Current	I _{TM}		100			μA
		TM Gain	A _{TM}			10		mV/°C
Digital Output [Fault Flag]	Fault or Standby	TM Disabled Current	I _{TM_DIS}	DC state with TM Voltage +/- 0.5V. This is a high impedance state.		0.0		mA
Signal Ground	SG							
 All control signals must be reference 	ced to this pin, with t	he exception of VC						
 SG is internally connected to -IN a 	nd -OUT							
Signal Type	State	Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
Analog Input / Output	Any	Maximum Allowable Current	I _{sg}		-100		100	mA

VTM Control	VC						
 Used to synchronize start up of downstream VTM converter. 							
 14V nominal, 10ms voltage pulse 							
 If not used, must be resistively terminated to -OUT 							
Signal Type	State						

Signal Type	State	Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
Analog Output Startup		VC Voltage	V _{vc}	R _{VC} = 68Ω	13			V
	Startup	VC Current Limit	Ivc	V _C = 14 V, V _{IN} > 20 V	200	500		mA
	Startup	VC duration	T _{vc}		7	10	16	ms
		VC Slew Rate	dVC/dt	$R_{VC} = 1k\Omega$		20		V/µs



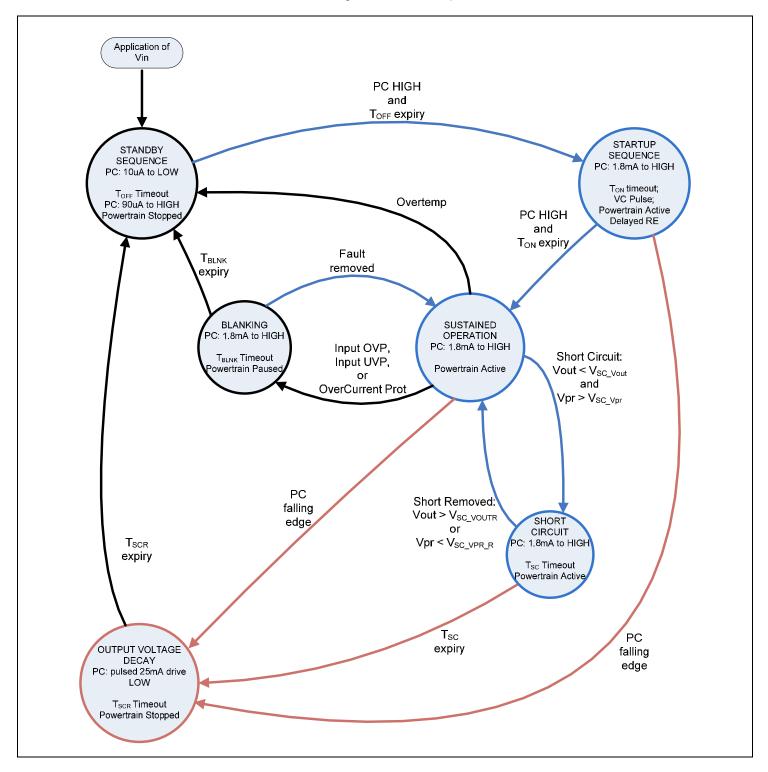
4.0 FUNCTIONAL BLOCK DIAGRAM





5.0 HIGH LEVEL FUNCTIONAL STATE DIAGRAM

Conditions that cause state transitions are shown along arrows. Sub-sequence activities listed inside the state bubbles.

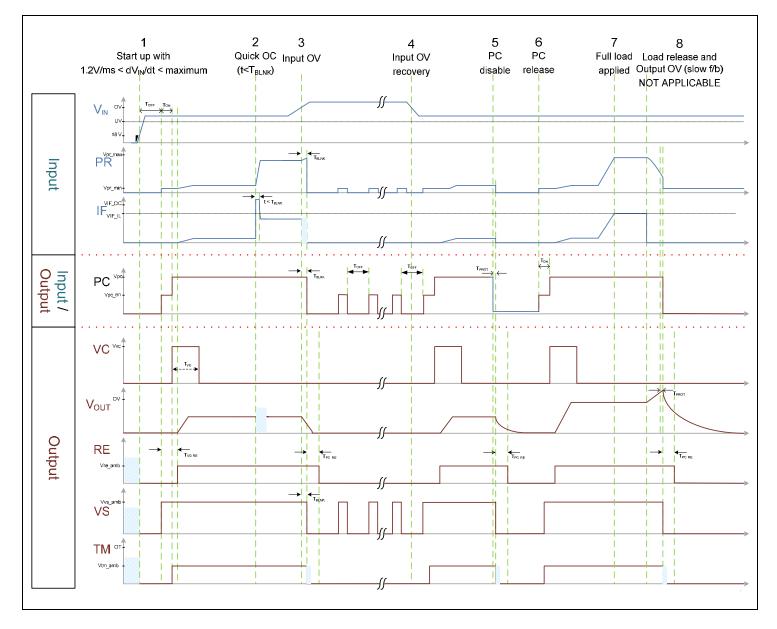




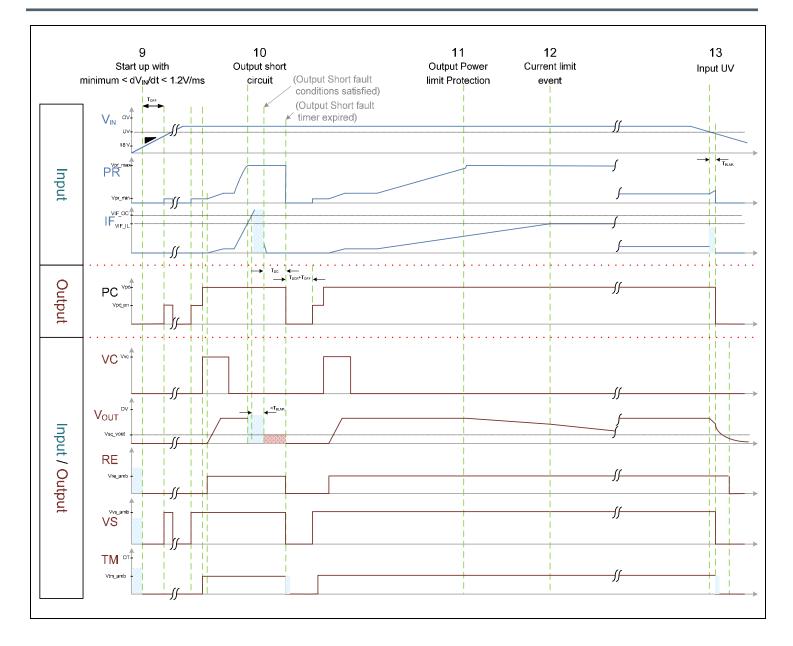
6.0 TIMING DIAGRAMS

Module Inputs are shown in blue; Module Outputs are shown in brown; Timing diagrams assumes the following:

- Single PRM (no array)
- > VS powers error amplifier
- > RE powers voltage reference and output current transducer
- I_{OUT} is sensed, scaled, and fed back to IF pin such that IF = 2.00 V at full load









7.0 APPLICATIONS CHARACTERISTICS

The following figures present typical performance at $T_c = 25^{\circ}C$, unless otherwise noted. See associated figures for general trend data.

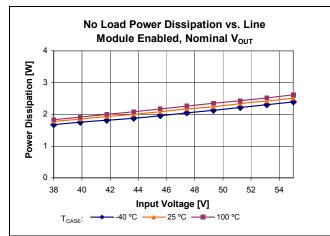


Figure 1 - No load power dissipation vs. V_{IN} , module enabled

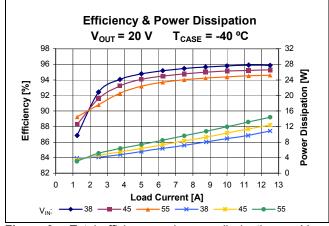


Figure 3 – Total efficiency and power dissipation vs. V_{IN} and $I_{\text{OUT}},\,V_{\text{OUT}}\text{=}20\text{V},\,T_{\text{CASE}}\text{=}\text{-}40^{\circ}\text{C}$

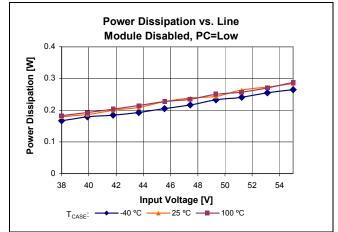


Figure 2 - No load power dissipation vs. $V_{\text{IN}},$ module disabled

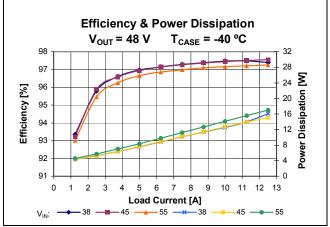


Figure 4 – Total efficiency and power dissipation vs. V_{IN} and I_{OUT} , V_{OUT} =48V, T_{CASE} =-40°C



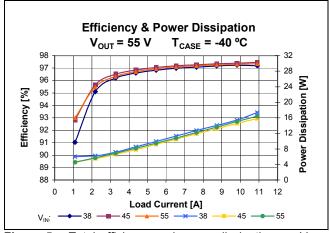


Figure 5 – Total efficiency and power dissipation vs. V_{IN} and $I_{\text{OUT}},\,V_{\text{OUT}}{=}55\text{V},\,T_{\text{CASE}}{=}{-}40^{\circ}\text{C}$

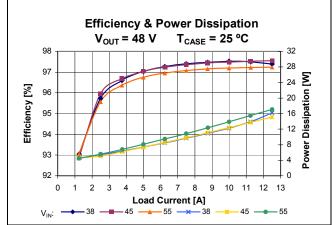


Figure 7 – Total efficiency and power dissipation vs. V_{IN} and I_{OUT} , V_{OUT} =48V, T_{CASE} =25°C

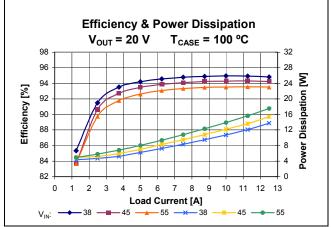


Figure 9 – Total efficiency and power dissipation vs. V_{IN} and $I_{\text{OUT}},\,V_{\text{OUT}}\text{=}20V,\,T_{\text{CASE}}\text{=}100^{\circ}\text{C}$

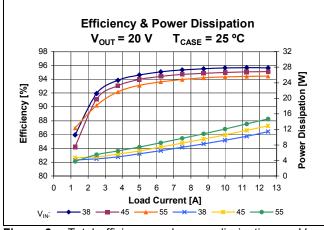


Figure 6 – Total efficiency and power dissipation vs. V_{IN} and $I_{\text{OUT}}, V_{\text{OUT}}\text{=}20V, T_{\text{CASE}}\text{=}25^{\circ}\text{C}$

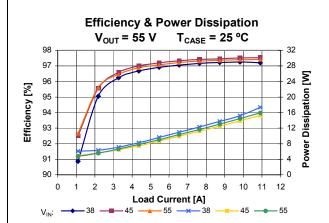


Figure 8 – Total efficiency and power dissipation vs. V_{IN} and $I_{\text{OUT}},\,V_{\text{OUT}}\text{=}55\text{V},\,T_{\text{CASE}}\text{=}25^{\circ}\text{C}$



Figure 10 – Total efficiency and power dissipation vs. V_{IN} and I_{OUT} , V_{OUT} =48V, T_{CASE} =100°C



Figure 11 – Total efficiency and power dissipation vs. V_{IN} and I_{OUT} , V_{OUT} =55V, T_{CASE} =100°C

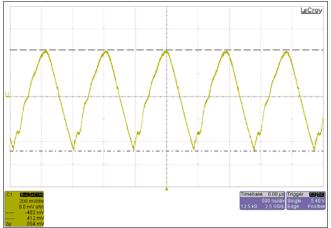


Figure 13 – Typical output voltage ripple waveform, T_{CASE} = 30°C, V_{IN} =45V, V_{OUT} =48V, I_{OUT} =12.5A, no external capacitance.

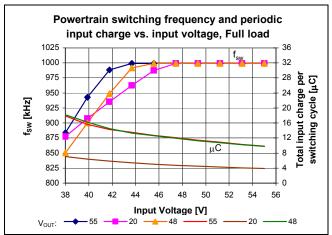


Figure 15 – Powertrain switching frequency and periodic input charge vs. V_{IN} , V_{OUT} ; I_{OUT} =12.5A

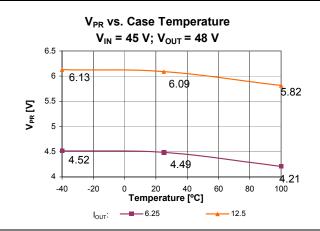


Figure 12 – Typical control node voltage vs. T_{CASE} , I_{OUT} ; V_{IN} =45V, V_{OUT} =48V

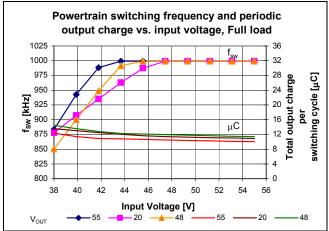


Figure 14 – Powertrain switching frequency and periodic output charge vs. V_{IN} , V_{OUT} ; I_{OUT} =12.5A

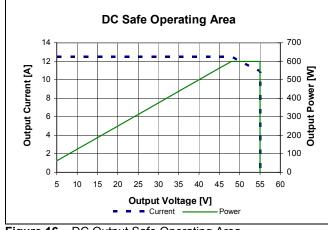


Figure 16 – DC Output Safe Operating Area



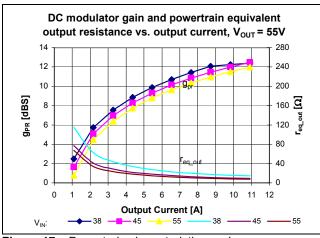


Figure 17 – Powertrain characteristics vs. I_{OUT} ; Resistive load, V_{OUT} =55V, various V_{IN}

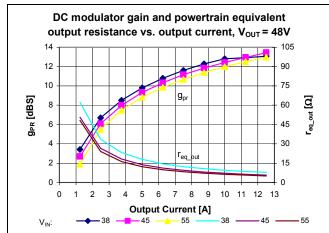


Figure 19 – Powertrain characteristics vs. I_{OUT} ; Resistive load, V_{OUT} =48V, various V_{IN}

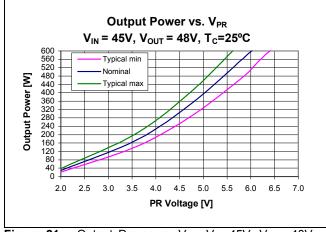


Figure 21 – Output Power vs. V_{PR} ; V_{IN} =45V, V_{OUT} =48V, T_{CASE} =25°C

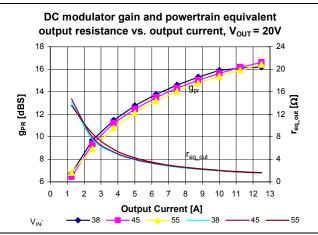


Figure 18 – Powertrain characteristics vs. I_{OUT} ; Resistive load, V_{OUT} =20V, various V_{IN}

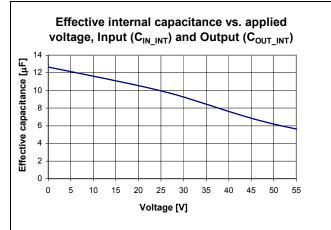


Figure 20 – Effective internal input and output capacitance vs. voltage – ceramic type

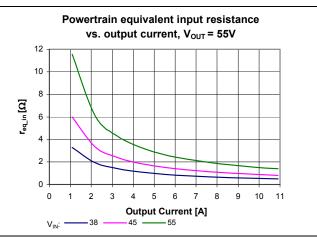


Figure 22 – Magnitude of powertrain dynamic input impedance vs. V_{IN} , I_{OUT} ; V_{OUT} =55V

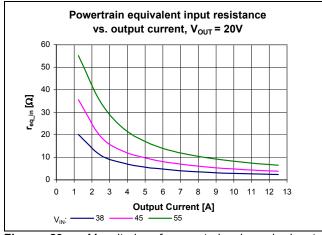


Figure 23 – Magnitude of powertrain dynamic input impedance vs. V_{IN} , I_{OUT} ; V_{OUT} =20V

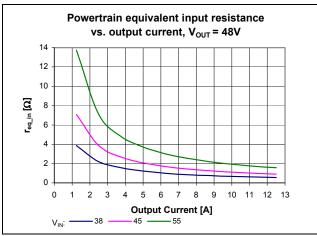
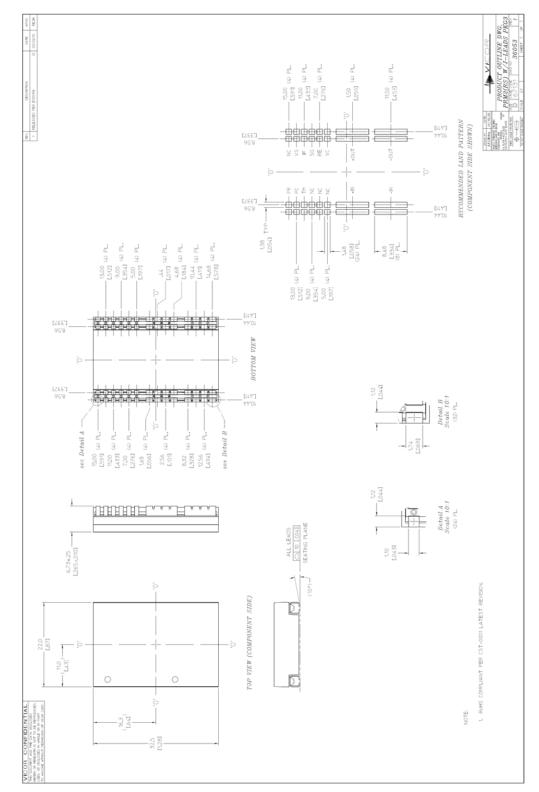


Figure 24 – Magnitude of powertrain dynamic input impedance vs. V_{IN} , I_{OUT} ; V_{OUT} =48V

8.0 GENERAL CHARACTERISTICS

		GENERAL CHARACTERISTICS				
		and trim from 20V to 55V, unless otherwise noted;				
		re range of -40 °C < T _J < 125 °C (T-Grade); All Other specifications are at T _J = 25 °C unless oth		-		T
Attribute MECHANICAL	Symbol	Conditions / Notes	Min	Тур	Max	Unit
			00.0 / 14.07	00.5 / 14.00	00.0 / / / 00	
Length	L			32.5 / [1.28]		
Width	W			22.0 / [0.87]		
Height	н		6.60 / [0.26]	6.73 / [0.26]	6.86 / [0.27]	mm / [in
Volume	Vol	No Heatsink		4.81 / [0.29]		cm ³ /[in ³
Weight	W			13.6		g
		Nickel	0.51		2.03	
Lead Finish		Palladium	0.02		0.15	μm
		Gold	0.003		0.051	
THERMAL						
Operating and Storage Junction Temperature	TJ		-40		125	°C
Operating Case Temperature	Tc		-40		100	°C
Thermal Capacity				10		Ws/°C
ASSEMBLY						
Peak Compressive Force Applied to		Supported by J-Lead only			6 5.41	lbs
Case (Z-axis)						lbs / in ²
Storage Temperature	T _{ST}		-40		125	°C
ESD Rating	ESD _{HBM}	Human Body Model, "JEDEC JESD 22-A114C.01"	1000			V
Lob ruling	ESD _{CDM}	Charged Device Model, "JEDEC JESD 22-C101D"	400			
SOLDERING						
Peak Temperature During Reflow		MSL 4 (Datecode 1528 and later)			245	°C
Maximum Time Above [217] °C					150	s
Peak Heating Rate During Reflow				1.5	2	°C/s
Peak Cooling Rate Post Reflow				2.5	3	°C/s
SAFETY						
MTBF		Telcordia Issue 2 - Method I Case 1; Ground Benign, Controlled		4.19		MHrs
		MIL-HDBK-217Plus Parts Count - 25C Ground Benign, Stationary, Indoors / Computer Profile	_	6.36		MHrs
Agency Approvala / Chanders		cTUV _{us}	_			4
Agency Approvals / Standards		CE Mark	_			4
		ROHS 6 of 6		I	I	



9.0 PRODUCT OUTLINE DRAWING AND RECOMMENDED PCB FOOTPRINT



10.0 PRODUCT DETAILS AND DESIGN GUIDELINES

10.1 Control pins description and characteristics

Control node (PR) is the input to the control node which determines the powertrain timing and ultimately the module output power (Figure 21). An internal 0.5mA current sink is always active. The bi-directional buffer between PR and the control node has two states. In normal operation, PR will be above the 0.79V switching threshold, and will drive the control node through the buffer. An internal 7.4V clamp determines the maximum output power that can be requested of the modulator.

When PR falls below 0.79 V, the converter will stop switching. An internal circuit clamps the modulator input control node to 0.79 V, and a buffer will source up to 2.5 mA out of the pin at that clamp level. For this reason, the output impedance of the amplifier driving PR must be taken into account. A rail-to-rail operational amplifier with low output impedance is always recommended.

The powertrain small signal (plant) response consists of a single pole determined by the load resistance, the powertrain equivalent output resistance, and the total output capacitance (internal and external to the module). Both the modulator gain and the equivalent output resistance vary as a function of line, load and output voltage, as shown in Figures 17, 18 and 19. As the load increases, the powertrain pole moves to higher frequency. As a result, the closed loop crossover frequency will be the highest at full load and lowest at minimum load. Figure 25 shows a reference AC small-signal model.

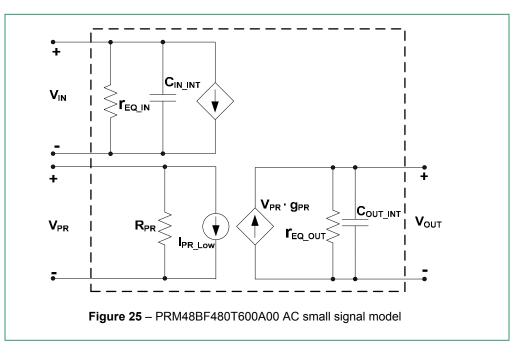
Current feedback (IF) is the input for the module output overcurrent protection and current limit features (see functional block diagram in section 4.0). A voltage proportional to the powertrain output current must be applied to IF in order for overcurrent protection to operate properly.

If the IF voltage exceeds the IF pin's overcurrent protection threshold, the powertrain will stop switching. If the IF voltage falls below the overcurrent protection threshold within T_{BLANK} time, then the powertrain will immediately resumes switching. Otherwise a fault is latched.

The current limit threshold for the IF pin is set lower than the protection threshold. When the IF pin average voltage exceeds the current limit threshold, an internal integrator will activate a clamp amplifier which overrides the modulator input maximum level. This causes the powertrain to maintain a constant output current.

The bandwidth of this current limit integrator is significantly slower than that of the PR control node input. Therefore this current limit can not be used in lieu of properly compensating the (external) PR control loop to avoid exceeding maximum current or power ratings for the device.

If the IF pin is not driven, it must be resistively terminated to SG. A $1k\Omega$ resistor to SG is recommended in this case.





VTM Control (VC) pin supplies an initial V_{CC} voltage to downstream VTMs, enabling them and synchronizing their startup with the PRM. The V_{CC} voltage is a pulse, typically 10ms duration at 14V.

If VC is not loaded by a VTM, it must be terminated with a $1k\Omega$ resistor to -VOut.

Primary Control (PC) is both an input and an output. It can provide the following features:

• Delayed start: upon application of voltage (>UVLO) to the module power input and after T_{OFF} , the PC pin will source a constant 90µA current.

• Output disable: PC may be pulled down externally in order to disable the module. Pull down resistance should be less than 300Ω to SG.

• Fault detection flag: The PC 5 V voltage source is internally turned off when a fault condition is latched. Note that aside from the Short Circuit fault condition, PC does not have significant current sinking capability. Therefore in the case of an array of PRMs with interconnected PC pins, PC does not in general reflect the fault state of all PRMs. The common PC line will not disable neighboring modules when a fault is detected except for a latched Output Short Circuit fault. Conversely any unit in the array latching a Short Circuit fault will disable the array for T_{SCR}.

Temperature Monitor (TM) pin outputs a voltage proportional to the absolute temperature of the converter analog control IC. It can be used to accomplish the following functions:

• Monitor the control IC temperature: The gain and setpoint of TM are such that the temperature, in Kelvin, of the PRM controller IC is equal to the voltage on the TM pin scaled by 100. (i.e. $3.0 \text{ V} = 300 \text{ K} = 27^{\circ}\text{C}$).

• Closed loop thermal management at the system level (e.g. variable speed fans or coolant flow)

• Fault detection flag: The TM voltage source is turned off as soon as a fault is detected. For system monitoring purposes (microcontroller interface) faults are detected on falling edges of TM.

Reference Enable (RE) pin outputs a regulated 3.3V, 8mA voltage source. It is enabled only after successful startup of the PRM powertrain (see chapters 5.0 and 6.0.) RE is intended to power the output current transducer and also the voltage reference for the control loop. Powering the reference generator with RE helps provide a controlled startup, since the output voltage of the system is able to track the reference level as it comes up.

Voltage Source (VS) pin outputs a gated (e.g. mirrors PC status), non-isolated, regulated 9V, 5mA voltage source. It can be used to power external control circuitry; it always leads RE.

Signal Ground (SG) pin provides a Kelvin connection to the PRM's internal signal ground. It should be used as the reference for PR, TM, IF, and should return all PC, VS and RE pin currents. In array configurations with common ground control circuits, a series resistor (~1 Ω) is recommended in order to decouple power and signal current returns.

10.2 Control circuit requirements and design procedure

The PRM48BF480T600A00 is an intelligent powertrain module designed to fully exploit external output voltage feedback and current sensing sub-circuits. These two external circuits are illustrated in Figure 26, which shows an example of the PRM in a standalone application with local voltage feedback and high side current sensing.

In general, these circuits include a precision voltage reference, an operational amplifier which provides closed loop feedback compensation, and a high side current sense circuit which includes a shunt and current sense IC.

The following design procedures refer to the circuit shown in Figure 26.

10.2.1 Setting the output voltage level

The output voltage setpoint is a function of the voltage reference and the output voltage sense ratio. With reference to Fig. 26, R1 and R2 form the output voltage sensing divider which provides the scaled output voltage to the negative input of the error amplifier; a dedicated reference IC provides the reference voltage to the positive input of the error amplifier. Under normal operation, the error amplifier will keep the voltages at the inverting and non-inverting inputs equal, and therefore the output voltage is defined by:

$$V_{OUT} = V_{ref} \cdot \frac{R1 + R2}{R2}$$

Note that the component R1 will also factor into the compensation as described in a later section.

It is important to apply proper slew rate to the reference voltage rise when the control loop is initially enabled. The recommended range for reference rise time is 1 ms to 9 ms. The lower rise time limit will ensure optimized modulator timing performance during startup, and to allow the current limit feature (through IF pin) to fully protect the device during power-up. The upper rise time limit is needed to guarantee a sufficient factorized bus voltage is provided to any downstream VTM input before the end of the VC pulse.

10.2.2 Setting the output current limit and overcurrent protection level

The current limit and overcurrent protection set points are linked, and scale together against the current sense shunt, and the gain of the current sense amplifier. The output of the current sense IC provides the IF voltage which has $V_{IF_{IL}}$ and $V_{IF_{OC}}$ thresholds for the two functions respectively. The set points are therefore defined by:

$$I_{IL} = \frac{V_{IF_IL}}{R_s \cdot G_{CS}}$$

and

$$I_{OC} = \frac{V_{IF_OC}}{R_s \cdot G_{CS}}$$

where G_{CS} is the gain of the current sense amplifier.

10.2.3 Control loop compensation requirements

In order to properly compensate the control loop, all components which contribute to the closed loop frequency response should be identified and understood. Figure 25 shows the AC small signal model for the module. Modulator DC gain g_{PR} and powertrain equivalent resistance r_{EQ_OUT} are shown. These modeling parameters will support a design cut-off frequency up to 50kHz.

Standard Bode analysis should be used for calculating the error amplifier compensation and analyzing the closed loop stability. The recommended stability criteria are as follows:

1) Phase Margin > 45° : for the closed loop response, the phase should be greater than 45° where the gain crosses 0dB.

2) Gain Margin > 10dB : The closed loop gain should be lower than -10dB where the phase crosses 0° .

3) Gain Slope = -20dB/decade : The closed loop gain should have a slope of -20dB/decade at the crossover frequency.

The compensation characteristics must be selected to meet these stability criteria. Refer to Figure 27 for a local sense, voltage-mode control example based on the configuration in Figure 26. In this example, it is assumed that the maximum crossover frequency (F_{CMAX}) has been selected to occur between B and C. Type-2 compensation (Curve IJKL) is sufficient in this case.

The following data must be gathered in order to proceed: Modulator Gain g_{PR} : See Figures 17, 18, 19

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- Powertrain equivalent resistance r_{EQ}: See Figures 17, 18, 19
 Internal output capacitance: see Figure 20
- External output capacitance. see Figure
 External output capacitance value

In the case of ceramic capacitors, the ESR can be considered low enough to push the associated zero well above the frequency of interest. Applications with high ESR capacitor may require a different type of compensation, or cascade control.

The system poles and zeros of the closed loop can then be defined as follows:

Powertrain pole, assuming the external capacitor ESR can be neglected:

$$R_{C_{OUT_EXT}} << \frac{r_{EQ_OUT} \cdot R_{LOAD}}{r_{EQ_OUT} + R_{LOAD}}$$

Main pole frequency:

$$F_{P} \approx \frac{1}{2\pi \cdot \frac{r_{EQ_OUT} \cdot R_{LOAD}}{r_{EQ_OUT} + R_{LOAD}} \cdot \left(C_{OUT_INT} + C_{OUT_EXT}\right)}$$

> Compensation Mid-Band Gain:

$$G_{\rm MB} = 20\log\frac{R_3}{R_1}$$
[1]

Compensation Zero:

$$\mathbf{F}_{\mathrm{Z1}} = \frac{1}{2\,\boldsymbol{\pi}\cdot\mathbf{R}_{3}\cdot\mathbf{C}_{1}}$$
[2]

Compensation Pole:

$$F_{P2} = \frac{1}{2\pi \cdot \frac{R_3 \cdot C_1 \cdot C_2}{C_1 + C_2}}$$

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and for $F_{P2} >> F_{Z1} (C_1 + C_2 \approx C_1)$:

$$\mathbf{F}_{P2} \approx \frac{1}{2\pi \cdot R_3 \cdot C_2}$$
 [3]

10.2.4 Midband Gain Design (R1,R3):

With reference to Figure 27: curve ABC is the:

- > minimum output voltage in the application
- maximum input voltage expected in the application
- maximum load

PRM open loop response, and is where the maximum crossover frequency occurs. In order for the maximum crossover frequency to occur at the design choice F_{CMAX} , the compensation gain must be equal and opposite of the powertrain gain at this frequency. For stability purposes, the compensation should be in the Mid-band (J-K) at the crossover. Using Equation [1], the mid-band gain can be selected appropriately.

10.2.5 Compensation Zero Design (C1):

With reference to Figure 27: curve EFG is the:

- maximum output voltage in the application
- minimum input voltage expected in the application
- minimum load in the application

PRM open loop response, and is where the minimum crossover frequency F_{CMIN} occurs. Based on stability criteria, the compensation must be in the mid-band at the minimum crossover frequency, therefore F_{CMIN} will occur where EFG is equal and opposite of G_{MB} . C1 can be selected using Equation [2] so that F_{Z1} occurs prior to F_{CMIN} .

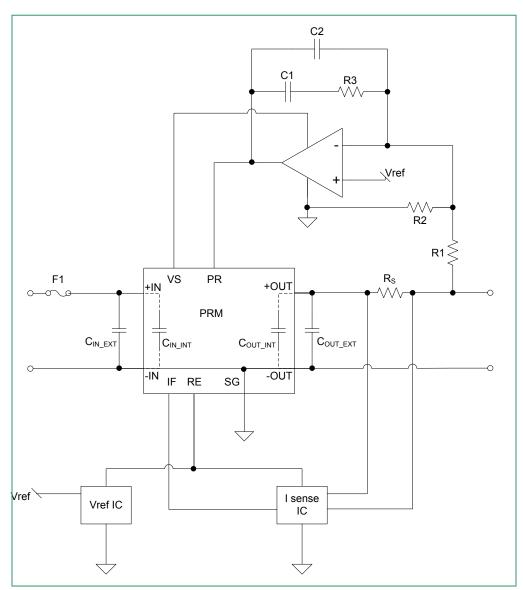
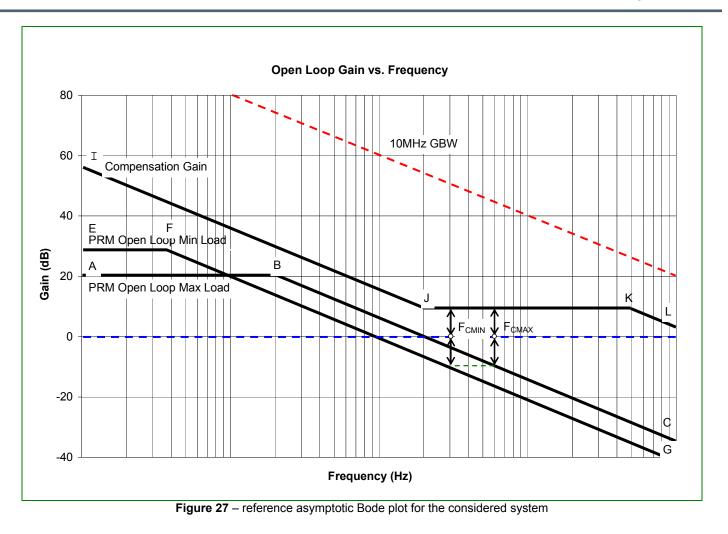


Figure 26 - Control circuit example





10.2.6 High Frequency Pole Design (C2):

Using Equation [3], C2 should be selected so that F_{P2} is at least one decade above F_{CMAX} and prior to the gain bandwidth product of the operational amplifier (10MHz for this example). For applications with a higher desired crossover frequency the use of a high gain bandwidth product amplifier may be necessary to ensure that the real pole can be set at least one decade above the maximum crossover frequency.

10.2.7 Verifying Stability:

The preferred method for verifying stability is to use a network analyzer, measuring the closed loop response across various lines and load conditions.

In the absence of a network analyzer, a load step transient response can be used in order to estimate stability.

Figure 28 illustrates an example of a load step response. Equation [4] can be used to predict the phase margin based on the ratio of the "kick" to "droop" (as defined in Fig. 28).

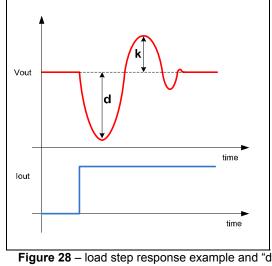


Figure 28 – load step response example and "droop" vs. "kick" definition



$$\Phi_m \approx 100 \sqrt{\frac{\left(\ln\frac{k}{d}\right)^2}{\left(\ln\frac{k}{d}\right)^2 + \pi^2}}$$
[4]

10.3 Burst Mode Operation:

At light loads, the PRM will operate in a burst mode due to minimum timing constraints. An example burst operation waveform is illustrated in Figure 29.

For very light loads, and also for higher input voltages, the minimum time power switching cycle from the powertrain will exceed the power required by the load. In this case the external error amplifier will periodically drive PR below the switching threshold in order to maintain regulation. Switching will cease momentarily until the error amplifier once again drives PR voltage above the threshold.

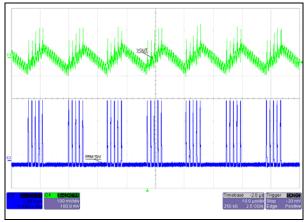


Figure 29 – light load burst mode of operation

Note that during the bursts of switching, the powertrain frequency is constant, but the number of pulses as well as the time between bursts is variable. The variability depends on many factors including input voltage, output voltages, load impedance, and external error amplifier output impedance.

In burst mode, the gain of the PR input to the plant which is modeled in the previous sections is time varying. Therefore the small signal analysis can not be directly applied to burst mode operation.

10.4 Input and Output filter design

Figures 14 and 15 provide the total input and output charge per cycle, as well as switching frequency, of the PRM at full load under various input and output voltages conditions.

Figure 20 provides the effective internal capacitance of the module. A conservative estimate of input and output peak-peak voltage ripple at nominal line and trim is provided by equation [5]:

$$\Delta V = \frac{Q_{TOT} - \frac{I_{FL} \cdot 0.4}{f_{SW}}}{C_{INT} + C_{EXT}}$$
[5]

 Q_{TOT} is the total input (Fig. 15) or output (Fig. 14) charge per switching cycle at full load, while C_{INT} is the module internal effective capacitance at the considered voltage (Fig. 20) and C_{EXT} is the external effective capacitance at the considered voltage.

10.5 Input filter stability

The PRM can provide very high dynamic transients. It is therefore very important to verify that the voltage supply source as well as the interconnecting line are stable and do not oscillate. For this purpose, the converter dynamic

input impedance magnitude $|r_{EQ_{IN}}|$ is provided in Figures 22, 23, 24. It is recommended to provide adequate design margin with respect to the stability conditions illustrated in 10.5.1 and 10.5.2.

10.5.1 Inductive source and local, external input decoupling capacitance with negligible ESR (i.e.: ceramic type)

The voltage source impedance can be modeled as a series $R_{\text{line}}L_{\text{line}}$ circuit. The high performance ceramic decoupling capacitors will not significantly damp the network because of their low ESR; therefore in order to guarantee stability the following conditions must be verified:

$$R_{line} > \frac{L_{line}}{(C_{IN_INT} + C_{IN_EXT}) \cdot \left| r_{EQ_IN} \right|} \quad [6]$$

$$R_{line} \ll \left| r_{EQ_{IN}} \right|$$
[7]

It is critical that the line source impedance be at least an octave lower than the converter's dynamic input resistance, [7]. However, R_{line} cannot be made arbitrarily low otherwise equation [6] is violated and the system will show instability, due to under-damped RLC input network.



10.5.2 Inductive source and local, external input decoupling capacitance with significant R_{CIN_EXT} ESR (i.e.: electrolytic type)

In order to simplify the analysis in this case, the voltage source impedance can be modeled as a simple inductor L_{line} . Notice that, the high performance ceramic capacitors $C_{\text{IN}_{-}\text{INT}}$ within the PRM should be included in the external electrolytic capacitance value for this purpose. The stability criteria will be

$$\left|r_{EQ_IN}\right| > R_{C_{IN_EXT}}$$
[8]

$$\frac{L_{line}}{C_{IN_EXT} \cdot R_{C_{IN}=EXT}} < \left| r_{EQ_IN} \right|$$
[9]

Equation [9] shows that if the aggregate ESR is too small – for example by using very high quality input capacitors (C_{IN_EXT}) – the system will be under-damped and may even become destabilized. Again, an octave of design margin in satisfying [8] should be considered the minimum.

10.6 Arrays

Up to ten PRMs of the same type may be placed in parallel to expand the power capacity of the system. The following high-level guidelines must be followed in order for the resultant system to start up and operate properly, and to avoid overstress or exceeding any absolute maximum ratings.

- –IN pins of all PRMs must be connected together. Both inductance and resistance from the common power source to each PRM should be minimized, and matched.
- Input voltage to all PRMs must be the same. Independent fuses for each PRM are recommended.
- PC pins must be connected together for synchronization and proper fault response.
- Reference supply to the control loop voltage reference and current sense circuitry must be enabled when all modules' RE pins have reached their operational voltage levels.
- There must be one single external voltage control loop. The control loop must drive each PR pin relative to each modules' SG pin, and the local PR voltage must be the same across all modules.
- Each PRM must have its own local current shunt and current sense circuitry to drive it's IF pin.
- The number of PRMs required to achieve a given array capacity must consider all sources of mismatch to avoid overstress of any PRM in the

Control loop compensation procedures above will hold for an array, in general, although many parameters must be scaled against the number of PRMs in the system.

Please contact Vicor Applications for assistance.

10.7 Input Fuse Recommendations

A fuse should be incorporated at the input to each PRM, in series with the +IN pin. A 15A or smaller input fuse (Littelfuse[®] NANO^{2®} 451/453 Series, or equivalent) is required to safety agency conditions of acceptability. Always ascertain and observe the safety, regulatory, or other agency specifications that apply to your specific application.

10.8 Layout considerations

Application Note AN:005 details board layout using VI Chip components. Additional consideration must be given to the external control circuit components.

The current sense shunt signal voltage is highly sensitive to noise. As such, current sensing circuitry should be located close to the shunt to minimize the length of the sense signals. A Kelvined connection at the shunt is recommended for best results.

The control signal from a remote voltage sense circuit to the PRM should be shielded. Avoid routing this, or other control signals directly underneath the PRM, if possible. Components that tie directly to the PRM should be located close to their respective pins. It is also critical that all control components be referenced to SG, and that SG not be tied to any other ground in the system, including –IN or –OUT of the PRM.



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